H7N0308CF

Silicon N Channel MOS FET High Speed Power Switching



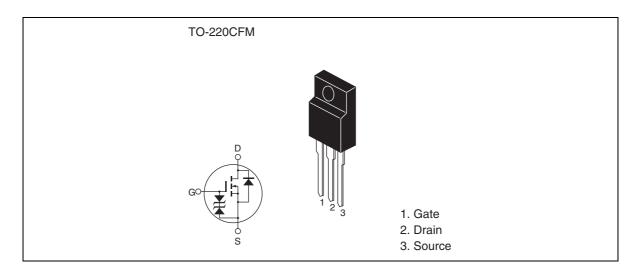
ADE-208-1570A(Z)

2nd. Edition Aug. 2002

Features

- Low on-resistance
- $R_{DS(on)} = 3.8 \text{ m}\Omega \text{ typ.}$
- Low drive current
- 4.5 V gate drive device can be driven from 5 V source

Outline



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Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit	
Drain to source voltage	V _{DSS}	30	V	
Gate to source voltage	V _{GSS}	±20	V	
Drain current	I _D	60	A	
Drain peak current	Note 1 D(pulse)	240	A	
Body-drain diode reverse drain current	I _{DR}	60	A	
Channel dissipation	Pch Note 2	30	W	
Channel to Case Thermal Impedance	θch-c	4.17	°C/W	
Channel to Ambient Thermal Impedance	θch-a	62.5	°C/W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. Value at Tc = 25°C

Electrical Characteristics

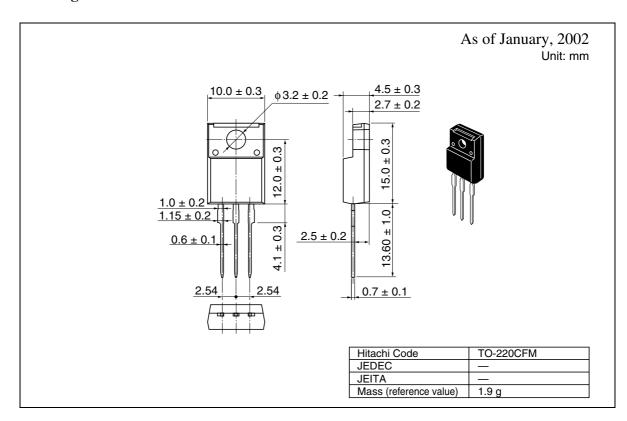
 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{_{(BR)DSS}}$	30	_	_	V	$I_{D} = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_			$I_{_{G}} = \pm 100 \ \mu A, \ V_{_{DS}} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	10	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{_{\text{GS(off)}}}$	1.0	_	2.5	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}^{\text{Note 1}}$
Static drain to source on state	$R_{\scriptscriptstyle DS(on)}$	_	3.8	4.8	mΩ	$I_{D} = 30 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note 1}}$
resistance		_	6.0	8.5	mΩ	$I_D = 30 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note 1}}$
Forward transfer admittance	ly _{fs} l	42	70	_	S	$I_{D} = 30 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note 1}}$
Input capacitance	Ciss		3350		pF	V _{DS} = 10V
Output capacitance	Coss	_	840	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	480	_	pF	f = 1 MHz
Total gate charge	Qg	_	52	_	nc	V _{DD} = 10 V
Gate to source charge	Qgs	_	11	_	nc	$V_{GS} = 10 \text{ V}$
Gate to drain charge	Qgd	_	10	_	nc	$I_{D} = 60 \text{ A}$
Turn-on delay time	t _{d(on)}		30		ns	$V_{GS} = 10 \text{ V}, I_{D} = 30 \text{A}$
Rise time	t _r	_	370	_	ns	$R_L = 0.33 \Omega$
Turn-off delay time	t _{d(off)}	_	80	_	ns	$R_g = 4.7 \Omega$
Fall time	t _f	_	27	_	ns	_
Body-drain diode forward voltage	V _{DF}	_	0.90	_	V	$I_{F} = 60 \text{ A}, V_{GS} = 0$
Body-drain diode reverse recovery time	t _{rr}		55		ns	$I_F = 60 \text{ A}, V_{GS} = 0$ diF/ dt = 50 A/ μ s

Notes: 1. Pulse test

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Package Dimensions



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